

# MULTI-INNO TECHNOLOGY CO., LTD.

## **LCD MODULE SPECIFICATION**

## Model : MI0800FT-5

Revision	1.0
Engineering	
Date	
Our Reference	

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## **REVISION RECORD**

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## CONTENTS

- GENERAL INFORMATION
- EXTERNAL DIMENSIONS
- ABSOLUTE MAXIMUM RATINGS
- ELECTRICAL CHARACTERISTICS
- ELECTRO-OPTICAL CHARACTERISTICS
- INTERFACE DESCRIPTION
- REFERENCE APPLICATION NOTES
- RELIABILITY TEST CONDITIONS
- INSPECTION CRITERION
- PRECAUTIONS FOR USING LCD MODULES
- PACKING SPECIFICATION
- PRIOR CONSULT MATTER



## ■ GENERAL INFORMATION

Item of general information	Contents	Unit
LCD size	8.0 (diagonal)	inch
LCD type	TFT/Normally White /Transmissive	/
Recommended Viewing Direction	6:00	O' Clock
Module area ( $W \times H \times T$ )	183.0×141.0×7.7	mm <sup>3</sup>
Active area (W×H)	162.4×121.5	mm <sup>2</sup>
Number of Dots	800RGB×600	/
Pixel pitch ( $W \times H$ )	0.0675×0.2025	mm <sup>2</sup>
Driver IC		/
Interface Type	24RGB interface	/
Input voltage	3.3	V
Module Power consumption	2138	mw
Backlight Type	LED	/
Weight		g



## EXTERNAL DIMENSIONS





## ■ ABSOLUTE MAXIMUM RATINGS

Parameter of absolute maximum ratings	Symbol	Min	Max	Unit
Power supply voltage	VCC	-0.3	5	V
Fower suppry voltage	AVDD	-0.5	13.5	V
	VGH	-13.0	19.0	V
	VGL	-12.0	2.0	V
	VGH-VGL	-	31.0	V
LED Reverse Voltage	Vr	-	1.2	V
LED Forward Current	If	-	25.0	mA
Operating temperature	Тор	-10	60	°C
Storage temperature	TST	-20	70	°C
Humidity	RH	-	90%(Max60 °C)	RH

## ELECTRICAL CHARACTERISTICS

#### **DC CHARACTERISTICS**

Parameter of DC characteristics	Symbol	Min	Тур	Max	Unit
	VCC	3.0	3.3	3.6	V
Dower voltage	VGH	15.3	16.0	16.7	V
rower voltage	VGL	-7.7	-7.0	-6.3	V
	AVDD	10.2	10.4	10.6	V
VCOM	VCOM	3.5	3.7	3.9	V
	Icc	-	5.5	10.0	mA
Current of nower supply	Iavdd	-	32.0	50.0	mA
Current of power suppry	IGH	-	0.2	0.5	mA
	IGL	-	0.2	1.0	mA
Input voltage 'H' level	VIH	0.7VCC	-	VCC	V
Input voltage 'L' level	VIL	0	-	0.3VCC	V

Note \*:DCLK,HS,VS,RSTB,UPDN,STLR,MODE,DITHB

## **BACKLIGHT CHARACTERISTICS**

Item of backlight characteristics	Symbol	Min.	Тур.	Max.	Unit	Condition
Voltage for LED backlight	VLED	9.3	9.9	10.5	V	If=180mA
Current for LED backlight	ILED	162	180	198	mA	Ta=25 ℃
LED life time	-	20000	-	-	Hr	

Note 1: Using condition: constant current driving method If=180mA(+/-10%).

Note 2: The 'LED life time' is defined as the module brightness decrease to 50% orginal brightness at  $Ta=25^{\circ}C$  and IL=180mA. The LED lifetime could be decreased if operating IL is lager than 180mA.



Item of electro-optical characteristics	Symbol	Condition	Min	Тур	Max	Unit	Remark	Note
Response time	Tr+ Tf		-	25	50	ms	FIG 1.	4
Contrast ratio	Cr		360	450	-		FIG 2.	1
Luminance uniformity	δ WHITE	$\emptyset = 0^{\circ}$	70	75	-	%	FIG 2.	3
Surface Luminance	Lv	1a-23 C	180	225	-	cd/m <sup>2</sup>	FIG 2.	2
Viewing angle $\theta$ range	$\emptyset = 90^{\circ}$	40	50	-	deg	FIG 3.		
		$\emptyset = 270^{\circ}$	60	70	-	deg	FIG 3.	6
	θ	$\emptyset = 0^{\circ}$	60	70	-	deg	FIG 3.	
		$\emptyset = 180^{\circ}$	60	70	-	deg	FIG 3.	
NTSC ratio			-	-	-	%	-	-
	Red x		-	-	-	-		
	Red y		-	-	-	-		
CIE (x, y) chromaticity	Green x	] A—0°	-	-	-	-		
	Green y	Ø=0°	-	-	-	-		5
	Blue x	$\Sigma = 0$ T <sub>a=25</sub> °C	-	-	-	-	110 2.	5
	Blue y	1a-25 C	-	-	-	-		
	White x		0.260	0.310	0.360	-		
[	White y		0.280	0.330	0.380	-		

#### ELECTRO-OPTICAL CHARACTERISTICS

Contrast Ratio(CR) is defined mathematically by the following formula. For more Note1. information see FIG 2 .:

Contrast Ratio =  $\frac{\text{Average Surface Luminance with all white pixels (P 1, P2, P 3, P4, P5)}{A}$ 

Average Surface Luminance with all black pixels (P1, P2, P3, P4, P5)

Surface luminance is the LCD surface from the surface with all pixels displaying white. Note2. For more information see FIG 2.

Lv = Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)

Note3. The uniformity in surface luminance ( $\delta$  WHITE) is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by minimum luminance of 5 points luminance. For more information see FIG 2.

 $\delta$  WHITE = <u>Minimum</u> Surface Luminance with all white pixels (P<sub>1</sub>, P<sub>2</sub>, P<sub>3</sub>, P<sub>4</sub>, P<sub>5</sub>)

Maximum Surface Luminance with all white pixels (P<sub>1</sub>, P<sub>2</sub>, P<sub>3</sub>, P<sub>4</sub>, P<sub>5</sub>)

- Note<sub>4</sub>. Response time is the time required for the display to transition from White to black(Rise and from black to white(Decay Time, Tf). For additional information see FIG 1.. Time, Tr)
- CIE (x, y) chromaticity ,The x,y value is determined by screen active area position 5. For Note5. more information see FIG 2.
- Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the Note6. conrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.
- Note7. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity and the testing data is base on TOPCON's BM-5 photo detector. CIE,
- For TFT transmissive module, Gray scale reverse occurs in the direction of panel viewing Note8. angle.











FIG.3. The definition of viewing angle





## ■ INTERFACE DESCRIPTION

Pin No.	Symbol	I/O	Function	Remark
1	NC		No connection	
2	NC		No connection	
3	NC		No connection	
4	NC		No connection	
5	GND	Р	Power ground	
6	V <sub>COM</sub>	I	Common voltage	
7	V <sub>CC</sub>	Р	Power for Digital circuit	
8	MODE	I	DE/SYNC mode select	Note3
9	DE	I	Data Input Enable	
10	VS	I	Vertical Sync Input	
11	HS	I	Horizontal Sync Input	
12	B7	I	Blue data(MSB)	
13	B6	I	Blue data	
14	B5	I	Blue data	
15	B4	I	Blue data	
16	B3	I	Blue data	
17	B2	I	Blue data	
18	B1	I	Blue data	
19	B0	I	Blue data(LSB)	
20	G7	I	Green data (MSB)	
21	G6	I	Green data	
22	G5	I	Green data	
23	G4	I	Green data	
24	G3	I	Green data	
25	G2	I	Green data	
26	G1	I	Green data	
27	G0		Green data (LSB)	
28	R7	I	Red data (MSB)	
29	R6	I	Red data	
30	R5	I	Red data	



54		B 1 1 4	
R4	l	Red data	
R3	I	Red data	
R2	I	Red data	
R1	I	Red data	
R0	I	Red data (LSB)	
GND	Р	Power ground	
DCLK	I	Sample clock	
GND	Р	Power ground	
L/R	I	Right/ left selection	Note2,5
U/D	I	Up/down selection	Note2,5
$V_{GH}$	Р	Gate ON voltage	
V <sub>GL</sub>	Р	Gate OFF voltage	
AV <sub>DD</sub>	Р	Power for Analog circuit	
RESET	I	Global reset pin.	Note1
NC		No connection	
V <sub>COM</sub>	I	Common voltage	
DITHB	I	Dithering function	Note 4
GND	Р	Power ground	
NC		No connection	
NC		No connection	
	R4         R3         R2         R1         R0         GND         DCLK         GND         L/R         U/D         VGH         VGL         AVDD         RESET         NC         UTHB         GND         NC         NC         NC         NC         NC         NC         NC         NC	R4       I         R3       I         R2       I         R1       I         R0       I         GND       P         DCLK       I         GND       P         L/R       I         VGH       P         VGL       P         AV <sub>DD</sub> P         RESET       I         NC       I         GND       P         NC       I         NC       NC	R4IRed dataR3IRed dataR2IRed dataR1IRed dataR0IRed data (LSB)GNDPPower groundDCLKISample clockGNDPPower groundL/RIRight/ left selectionU/DIUp/down selectionVGHPGate ON voltageVGLPGate OFF voltageAVDDPPower for Analog circuitRESETIGlobal reset pin.NCNo connectionV <sub>COM</sub> IDithering functionGNDPPower groundNCNo connectionNCNo connectionNCNo connectionNCNo connectionNCNo connectionNCNo connectionNCNo connectionNCNo connectionNCNo connectionNCNo connection

I: input, O: output, P: Power

Note 1: Global reset pin. Active Low to enter Reset State. Suggest to connecting with an RC reset circuit for stability. Normally pull high.

Note 2: Selection	of scanning	mode
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Setting of scan control input		Scanning direction
U/D	R/L	
GND	V <sub>CC</sub>	Up to down, left to right
V <sub>CC</sub>	GND	Down to up, right to left
GND	GND	Up to down, right to left
V <sub>CC</sub>	V <sub>CC</sub>	Down to up, left to right

Note 3: DE/SYNC mode select, Normally pull high.

H: DE mode.

L: HS/VS mode.

Note4: Dithering function enable control.Normally pull high.

- DITHB="1",Disable internal dithering function. For 18bit RGB interface, connect two LSB bits of all the R/G/B data buses to GND.
- DITHB="0",Enable internal dithering function, For TTL 24bit parallel RGB image data input.



## Backlight Unit Section

Pin No.	Symbol	I/O	Function	Remark
1	$V_{LED^+}$	Р	Power for LED backlight anode	Pink
2	$V_{LED}$	Р	Power for LED backlight cathode	Black

## ■ **REFERENCE APPLICATION NOTES**

- 1.1 Timing Characteristics
  - 1.1.1 AC Electrical Characteristics

ltom	Symbol		Values	Unit	Pomark	
nem	Symbol	Min.	Тур.	Max.	Unit	Kemark
HS setup time	Thst	8	-	-	Ns	
HS hold time	Thhd	8	-	-	Ns	
VS setup time	Tvst	8	-	-	Ns	
VS hold time	$T_{vhd}$	8	-	-	Ns	
Data setup time	Tdsu	8	-	-	Ns	
Data hole time	Tdhd	8	-	-	Ns	
DE setup time	Tesu	8	-	-	Ns	
DE hole time	Tehd	8	-	-	Ns	
VDD Power On Slew rate	Tpor	-	-	20	ms	
RSTB pulse width	TRst	10	-	-	us	
CLKIN cycle time	Tcoh	20	-	-	Ns	
CLKIN pulse duty	Tcwh	40	50	60	%	
Output stable time	Tsst	-	-	6	us	



## 1.1.2 Timing

Itom	Symbol		Values		Unit	Remark
item	Symbol	Min.	Тур.	Max.	Unit	
Horizontal Display Area	thd	-	800	-	DCLK	
DCLK Frequency	fclk	-	40	50	MHz	
One Horizontal Line	th	862	1056	1200	DCLK	
HS pulse width	thpw	1	-	40	DCLK	
HS Back Porch(Blanking)	thb	46	46	46	DCLK	
HS Front Porch	thfp	16	210	354	DCLK	

Itom	Symbol		Values	Unit	Remark	
item	Symbol	Min.	Тур.	Max.	onit	Remark
Vertical Display Area	tvd	-	600	-	TH	
VS period time	tv	624	635	700	TH	
VS pulse width	tvpw	1	-	20	TH	
VS Back Porch(Blanking)	tvb	23	23	23	TH	
VS Front Porch	t∨fp	1	12	77	ΤН	



#### 1.1.3 Timing Diagram



Figure 3.1 Input Clock and Data Timing Diagram







## 1.2 Power Sequence

1.2.1 Power on.



 $VCC \rightarrow VGL \rightarrow VGH \rightarrow Data \rightarrow B/L$ 





Note: Data include R0~R5, B0~B5, GO~G5, STLR, UPDN, DCLK, HS, VS, DE.



#### ■ RELIABILITY TEST CONDITIONS

No.	Test Item	Test Condition	Inspection after test
1 2 3 4	High Temperature Storage Low Temperature Storage High Temperature Operating Low Temperature Operating	$70 \pm 2^{\circ}C/240$ hours - $20 \pm 2^{\circ}C/240$ hours $60 \pm 2^{\circ}C/240$ hours - $10 \pm 2^{\circ}C/240$ hours - $20 \pm 2^{\circ}C/240$ hours	Inspection after 2~4hours storage at
5	Temperature Cycle storage	$-20 \pm 2 \text{ C} \sim 25 \sim 70 \pm 2 \text{ C} \times 10 \text{ cycles}$ (30min.) (5min.) (30min.)	room temperature, the sample shall be free from
6	Damp proof Test operating	$40^{\circ}\text{C} \pm 5^{\circ}\text{C} \times 90\%$ RH/240 hours	defects:
7	Vibration Test	Frequency: 10Hz~55Hz~10Hz Amplitude: 1.5mm, X, Y, Z direction for total 3hours (Packing condition)	<ol> <li>1.Air bubble in the LCD;</li> <li>2.Sealleak;</li> <li>3.Non-display;</li> <li>4.missing segments;</li> </ol>
8	Dropping test	Drop to the ground from 1m height, one time, every side of carton. (Packing condition)	5.Glass crack; 6.Current Idd is twice higher than initial value.
9	ESD test	Voltage:±8KV R: 330Ω C: 150pF Air discharge, 10time	

Remark:

1. The test samples should be applied to only one test item.

2. Sample size for each test item is  $5 \sim 10$  pcs.

3.For Damp Proof Test, Pure water(Resistance>10M $\Omega$ ) should be used.

4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.

5.EL evaluation should be excepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.

6.Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.



## ■ INSPECTION CRITERION

MI	OUTGOING QUALITY STANDARD	PAGE 1 OF 7	
TITLE:FUNCTION	AL TEST & INSPECTION CRITERIA		

This specification is made to be used as the standard acceptance/rejection criteria for Color mobile phone LCM with touch panel.

## 1 Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

Major defect: AQL 0.65

Minor defect: AQL 1.5

2. Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of  $20 \sim 40$ W light intensity, all directions for inspecting the sample should be within  $45^{\circ}$  against perpendicular line.

3. Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD.

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.



#### OUTGOING QUALITY STANDARD

PAGE 2 OF 7

## TITLE: FUNCTIONAL TEST & INSPECTION CRITERIA

## 4. Inspection standards

## 4.1 Major Defect

MF

Item No	Items to be inspected	Inspection Standard	Classification of defects
4.1.1	All functional defects	<ol> <li>No display</li> <li>Display abnormally</li> <li>Missing vertical, horizontal segment</li> <li>Short circuit</li> <li>Back-light no lighting, flickering and abnormal lighting.</li> </ol>	
4.1.2	Missing	Missing component	Major
4.1.3	Outline dimension	Overall outline dimension beyond the drawing is not allowed.	
4.1.4	linearity	No more than 1.5%	

#### 4.2 Cosmetic Defect

Item No	Items to be inspected		Classification of defects			
	Clear Spots Black and white Spot defect	Par Spots For dark/white spot, size $\Phi$ is defined as $\Phi = \frac{(x+y)}{2}$ Ck and ite Spot Acceptable Oty				
	Pinhole,	Size(mm)	А	В	C	Minor
	Foreign	Φ ≤ 0.1	Igr	nore		
	Particle,	$0.10 < \Phi \le 0.15$	2		Ignore	
	polarizer Dirt	$0.15 < \Phi \le 0.20$	1			
4.2.1		0.20<Φ		0		
		2.				
		Zone	Acceptable (		ty	
		Size(mm)	А	В	C	
	Clear Spots	Φ≤0.1	Igr	nore		Minan
	TP Dirt	0.10<Φ≤0.15		3	Ignore	Minor
		$0.15 < \Phi \leqslant 0.25$	2			
		0.25<Φ		0		



OUTGOING QUALITY STANDARD				RD	PAGE	3 OI	5 7
TITLE: F	UNCTIONAL T	EST & INSPECTION	N CRITERIA	A			
	Dim Spots	3. 2. Zone Size(mm)	Α	Acceptable B	Qty C		
	Circle	Φ≤0.2	Ignore		Ignore		Minor
	shaped and dim edged defects	$0.20 < \Phi \le 0.40$		2	Ignoro		
		$0.40 < \Phi \le 0.60$		1	Ignore		
		0.60<Φ		0			

## 4.2 Cosmetic Defect

Item No	Items to be inspected		Classification of defects				
		S	A	Acceptable			
	Line defect	I (I ength)	W(Width)		zone		
	Black line,	L(Length)	w ( w luii)	А	В	C	
	White line, Foreign	Ignore	W≤0.02	Ig	nore		
	material on polarizer	L≤3.0	0.02 <w<0.03< td=""><td></td><td>2</td><td></td><td></td></w<0.03<>		2		
	1	L≤2.0	0.03 <w<0.05< td=""><td></td><td>1</td><td>Ignore</td><td></td></w<0.05<>		1	Ignore	
1.0.0			0.05 <w< td=""><td>Define</td><td>e as spot efect</td><td></td><td></td></w<>	Define	e as spot efect		
4.2.2		The line can condition:	The line can be seen after mobile phone in the c condition:		operating	Minor	
		size(mm) Acceptable Qty			Qty		
	Foreign	I (I ength)	(Longth) W(W; 4th)		zone		
	material on TP film	L(Length)	L(Length) W(Width)	А	В	C	
		Ignore	W≤0.03	Ign	ore		
		L≤5.0	0.03 <w≪ 0.05</w≪ 	3		Ignore	
			0.05 <w< td=""><td>Define as</td><td>spot defect</td><td></td><td></td></w<>	Define as	spot defect		
		If the scra assembling defect of 4.2	If the scratch can be seen after mobile phone cover assembling or in the operating condition, judge by the line defect of 4.2.2.				
		If the scratc some specia	h can be seen on al angle, judge by	ly in non- the follo	operating wing.	condition o	r



OUTGOING QUALITY STANDARD						PAGE	4 OF	7	
TI	LE:FU	NCTIONAL TE	EST & INSPECTI	ON CRITERIA					
		Dim line defect	Size	e(mm)	A	Acceptable Qty			
		uciece	L(Length)	W(Width)	Α	Zone			
	4.2.3	Polarizer scratch	Ignore	W≤0.03	Ign	nore			Minor
	TP	TP film scratch	5.0 <l≤10.0< td=""><td>0.03<w≤0.05< td=""><td></td><td>2</td><td>-</td><td></td></w≤0.05<></td></l≤10.0<>	0.03 <w≤0.05< td=""><td></td><td>2</td><td>-</td><td></td></w≤0.05<>		2	-		
			L≤5.0	0.05 <w≤0.08< td=""><td></td><td>1</td><td>- Ignore</td><td></td><td></td></w≤0.08<>		1	- Ignore		
				0.08 <w< td=""><td>(</td><td>0</td><td></td><td></td><td></td></w<>	(	0			
			Air bubbles betw	veen glass & pola	izer				
			2. Zone Acce		ceptabl	eptable Qty			
			Size(mm)	A	В		С		
	4.2.4 Polariz	Polarize Air bubble	Φ≤0.2	Ignor	·e				Minor
			$0.20 < \Phi \le 0.30$	0 2			Ignore		
			$0.30 < \Phi \le 0.50$	0 1					
			0.50<Φ	0					

## 4.3. Cosmetic Defect

Item No	Items to be inspected	I	Inspection Standard			
		(i) Chips on corner A:LCD Glass defect z x $\leq 2.0$ Notes: S=contact p Chips on the corner of to the ITO pad or expose p	$Y$ $\leq S$ ad length erminal shall not b erimeter seal.	Z Disregard be allowed to exten	nd into	Minor







#### OUTGOING QUALITY STANDARD

PAGE 6 OF 7

#### TITLE: FUNCTIONAL TEST & INSPECTION CRITERIA

#### 4.4 Parts Defect

MIE

Item No	Items to be inspected	Inspection Standard	Classification of defects	
	4.4.1 Parts contraposition	<ol> <li>Not allow IC and FPC/heat-seal lead width is more than 50% beyond lead pattern.</li> <li>Not allow chip or solder component is off center more than 50% of the pad outline.</li> </ol>	Major	
	4.4.2 SMT	According to the <acceptability assemblies="" electronic="" of=""> IPC-A-610C class 2 standard. Component missing or function defect are Major defect, the others are Minor defect.</acceptability>		







## ■ PRECAUTIONS FOR USING LCD MODULES

#### **Handing Precautions**

(1) The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.

(2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.

(3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).

(4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.

(5) If the display surface becomes contaminated, breather on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents

- Isopropyl alcohol

- Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

(6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.

- Water

- Ketone

- Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.

(7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.

(8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.

(9) Do not attempt to disassemble or process the LCD module.

(10) NC terminal should be open. Do not connect anything.

(11) If the logic circuit power is off, do not apply the input signals.

(12) Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

- Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.

- Tools required for assembling, such as soldering irons, must be properly grounded. make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.

- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential

- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated

(13) Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

- Do not alter, modify or change the shape of the tab on the metal frame.

- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.

- Do not damage or modify the pattern writing on the printed circuit board.

- Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.

- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.

- Do not drop, bend or twist LCM.



#### Handling precaution for LCM

LCM is easy to be damaged. Please note below and be careful for handling. Correct handling:





As above picture, please handle with anti-static gloves around LCM edges.

#### **Incorrect handling:**



Please don't touch IC directly.



Please don't hold the surface of panel.



Please don't hold the surface of IC.



Please don't stack LCM.



Please don't stretch interface of output, such as FPC cable.



Please don't operate with sharp stick such as pens.



#### **Storage Precautions**

When storing the LCD modules, the following precaution is necessary.

(1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for the dessicant.

(2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH.

(3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the anti-static electricity container in which they were shipped.

#### Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.

If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

- Exposed area of the printed circuit board.

-Terminal electrode sections.



## ■ USING LCD MODULES

#### Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

(1) Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



(2) When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be  $\pm 0.1$  mm.

#### Precaution for assemble the module with BTB connector:

Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows



#### Precaution for soldering the LCM

	Manual soldering	Machine drag soldering	Machine press soldering
No DoUS	290°C ~350°C.	330°C ~350°C.	300°C ~330°C.
nu Kulis	Time : 3-5S.	Speed : 4-8 mm/s.	Time : 3-6S.
product			Press: 0.8~1.2Mpa
DoUS	340°C ∼370°C.	350°C ~370°C.	330°C ~360°C.
nroduct	Time : 3-5S.	Time : 4-8 mm/s.	Time : 3-6S.
product			Press: 0.8~1.2Mpa

(1) If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.

(2) When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.

(3) When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

#### **Precautions for Operation**

(1) Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.

(2) It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.

(3) Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, Which will come back in the specified operating temperature.

(4) If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.

(5) A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.

(6) Input logic voltage before apply analog high voltage such as LCD driving voltage when power on. Remove analog high voltage before logic voltage when power off the module. Input each signal after the positive/negative voltage becomes stable.

(7) Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.



#### Safety

(1) It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.

(2) If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

#### Limited Warranty

Unless agreed betweenMulti-Inno and customer,Multi-Inno will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Multi-Inno LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date shall be based on data code on product. The warranty liability of Multi-Inno limited to repair and/or replacement on the terms set forth above. Multi-Inno will not be responsible for any subsequent or consequential events.

#### **Return LCM under warranty**

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :

- Broken LCD glass.
- PCB eyelet is damaged or modified.
- PCB conductors damaged.
- Circuit modified in any way, including addition of components.
- PCB tampered with by grinding, engraving or painting varnish.
- Soldering to or modifying the bezel in any manner.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

## ■ PRIOR CONSULT MATTER

- 1. TFor Multi-Inno standard products, we keep the right to change material, process ... for improving the product property without notice on our customer.
  - <sup>(2)</sup>For OEM products, if any change needed which may affect the product property, we will consult with our customer in advance.
- 2. If you have special requirement about reliability condition, please let us know before you start the test on our samples.